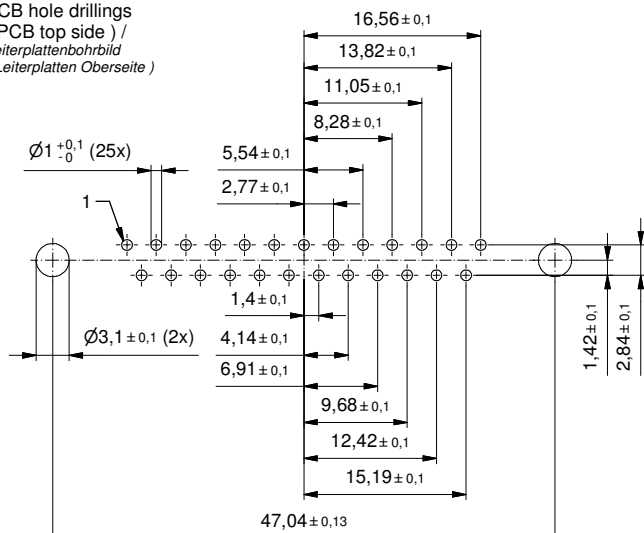


PCB hole drillings
(PCB top side) /
Leiterplattenbohrbild
(Leiterplatten Oberseite)



Technical specification:

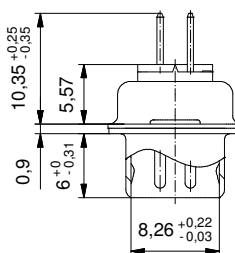
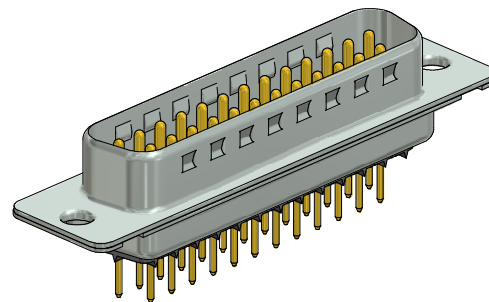
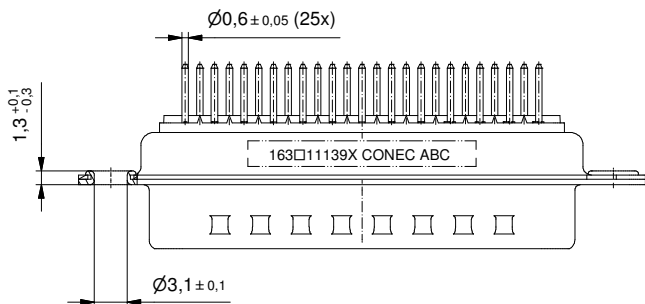
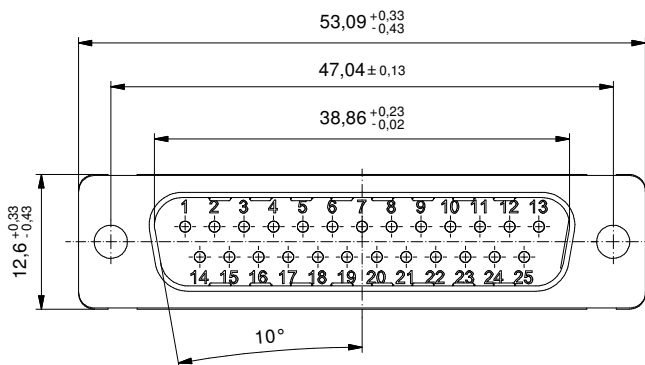
Technische Daten:

Working voltage/ Betriebsspannung:	125 V AC
Insulation resistance/ Isolationswiderstand:	≥5 GΩ
Dielectric withstanding voltage/ Spannungsfestigkeit:	1000 V, 50 Hz, 1 min.
Temperature range/ Temperaturbereich:	-55 °C ... +125 °C
Current rating/ Strombelastbarkeit:	7,5 A (UL) / 5 A (CSA, VDE)
Mating cycles/ Steckzyklen:	Quality class 1 = 500 Gütestufe 1 Quality class 2 = 200 Gütestufe 2 Quality class 3 = 50 Gütestufe 3

Materials/

Werkstoffe:

Contact/ Kontakt:	Cu alloy, Au over Ni
Insulator/ Isolierkörper:	PBT GF UL 94 V-0, black/schwarz
Shell/ Gehäuse:	Steel, Sn over Ni



b

Part no. / Part Marked/ <i>Art.-Nr. / Bedruckung:</i>		Contact plating/ <i>Kontakt Veredelung:</i>	
163A11139X		Gold Flash over Nickel <i>Gold über Nickel</i>	
163B11139X		20 µin Hard Gold over min. 50 µin Nickel <i>20 µin Gold über min. 50 µin Nickel</i>	
163C11139X		30 µin Hard Gold over min. 50 µin Nickel <i>30 µin Gold über min. 50 µin Nickel</i>	
 dim. in mm		D-SUB Male 25pol. <	

CONEC